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LTR						D	ESC	RIPT	ION									DATE	(YR-	MO-D/	A)	AP	PRO	VED	
ci fi	hip ca rom ca	onvert to military drawing format. Add case outline 2 (square lip carrier package) for vendor CAGE 27014. Remove vendor come case A and add to case D. Device OI case outline 2 factive for new design. Editorial changes throughout.									1														
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Device for nev	w des	qn	as of	16	Apri	1 8	<u>6.</u>			8				•											
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REV SHEET REV SHEET REV STATI OF SHEE	TS	s	HEET		1 PPF	2 PARE	3 D BY	4	5	6	7	8	$\overline{}$	10	EFE	NSE		CTRO TON,				CEN	TER		
REV SHEET REV SHEET REV STATE OF SHEEF PMIC N/A	iDAF	s DI	HEET		PRE CHI	2 PARE CKE	3 D BY	4	5 cen	6	7	8	9	10			DAY	TON,	OHI	0 45	444				
REV SHEET REV SHEET REV STATT OF SHEE PMIC N/A STAN	TS	s RDIZ ARY	ZED		PRE CHI	2 PARE	3 D BY	4 M	5 cen	6	7	8	9 M T	10	CIR E 3	CUI	DAY	TON,	OH!	O 45	444 [GH-		D C	Mos,	

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1. SCOPE							
1.1 Scope. This drawing describes device with 1.2.1 of MIL-STD-883, "Provisions for non-JAN devices".	e require the use o	ments f MIL-	for class B mi STD-883 in com	icrocircuit njunction w	s in accordance ith compliant		
1.2 Part number. The complete part number	er shall	be as	shown in the	following e	xample:		
84038 01			<u> </u>		X I		
			i				
Drawing number Device (1.2.)			se outline (1.2.2)		finish per L-M-38510		
1.2.1 Device type. The device type sha	ll identif	y the	circuit funct	ion as foll	ows:		
Device type Generic number	<u>r</u>		Circuit fun	ction			
01 54HC10 :		Tr	iple 3-input	NAND gate			
1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:							
Outline letter	<u>c</u>	ase ou	tline				
B F- C D- F-	3 (14-lead 1 (14-lead 2 (14-lead	280 785 390 	" x .260" x . .358" x .358"	070"), flat 200"), dual 085"), flat	package -in-line package package		
1.3 Absolute maximum ratings.							
Supply voltage range 1/ DC input voltage DC output voltage Clamp diode current DC output current (per pin) DC VCC or GND current (per pin) Storage temperature range Maximum power dissipation, Pp Lead temperature (soldering 10 secon Thermal resistance, junction to case Cases A, B, C, D, and 2 Junction temperature (TJ)				dc to +7.0 dc to VCC 4 dc to VCC 4	0.5 Y dc 0.5 Y dc		
1.4 Recommended operating conditions.							
Supply voltage Case operating temperature range (Tinput rise or fall time: VCC = 2.0 V	C)		+2.0 V -55°C 1 0 to 1, 0 to 50 0 to 40	Ons	V dc		
1/ Unless otherwise specified, all voltage For T _C = +100°C to +125°C, derate line	es are re early at 1	ferenc 2 mW/°	ed to ground. C.				
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DAYTON, OHIO 45444	1		l n		2		

2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 Truth table. The truth table shall be as specified on figure 2.
 - 3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

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	<u></u>	ABLE I. Elect	rical per	forman	ce character	istics.			
Test	 Symbol	-55°	Condit C < T _C < s otherwi	ions +125°C	, 1/	Group A	i i	fts	 Unit
	1	unles	s otherwi	se spe	cified	subgroups	Min	Max	1
High level output voltage	VOH		NIF	V _{CC}	= 2.0 V	1, 2, 3	1.9	 	V
				VCC	= 4.5 V	1	4.4	<u> </u> 	i
	<u> </u> -			v _{CC}	= 6.0 V	<u> </u>	5.9	<u>i</u> !	
		$ V_{IN} = V_{IH} \text{ or }$ $ I_0 \leq 4.0 \text{ m/s}$	AIF	VCC	= 4.5 V	<u> </u>	3.7	<u> </u>	
		VIN = VIH or 1101 < 5.2 m/	V _{IL}	V _{CC}	= 6.0 V		5.2	 	
Low level output voltage	v _{OL}		v _{IL}	v _{CC}	= 2.0 V	1, 2, 3		0.1	V
	1			Vcc	= 4.5 V		 	0.1	 -
				VCC	= 6.0 V			0.1	
		$ V_{IN} = V_{IH} \text{ or } V_{IO} \leq 4.0 \text{ m/s}$, A ^{IΓ}	VCC	= 4.5 V	1 1	 	0.4	1
		VIN = VIH or	['] ν ^{IΓ}	V _{CC}	= 6.0 V			0.4	-
High level input voltage	VIH			VCC	= 2.0 V	1, 2, 3	1.5	 	V
	 	 		V _{CC}	= 4.5 V	T 	3.15		
	 	 		V _{CC}	= 6.0 V		4.2		
Low level input voltage	V _I L	! !		Vcc	= 2.0 V	1, 2, 3		0.3	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
	 	1		VCC	= 4.5 V		<u> </u>	0.9	<u> </u>
	! 		,, , , , , , , , , , , , , , , , , , ,	VCC	= 6.0 V			1.2	
Input capacitance	<u> </u>	 V _{IN} = 0 V See 4.3.1c	T _C = +2	:5°C		4	 	10	pF
See footnotes at er						T	<u> </u>		
STANDA			SIZE A						
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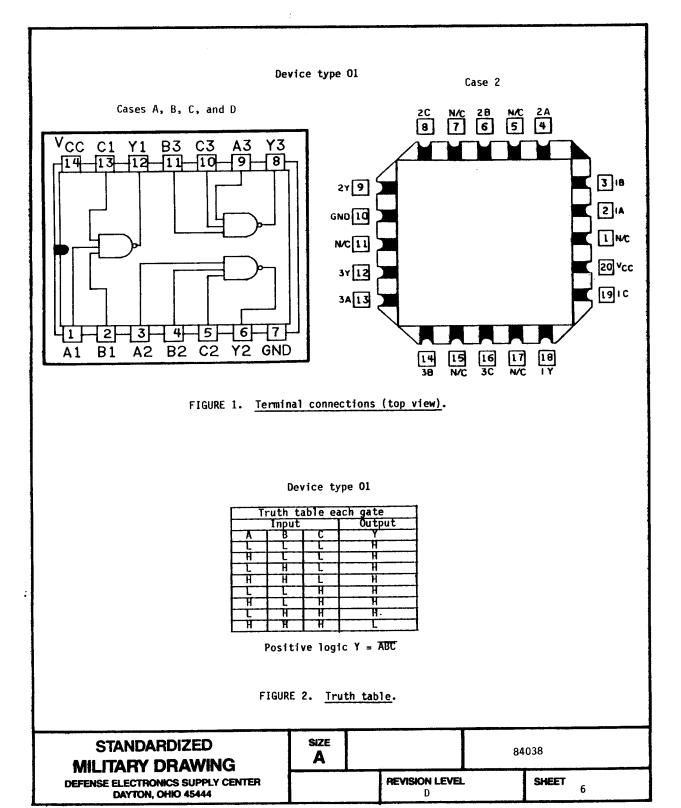
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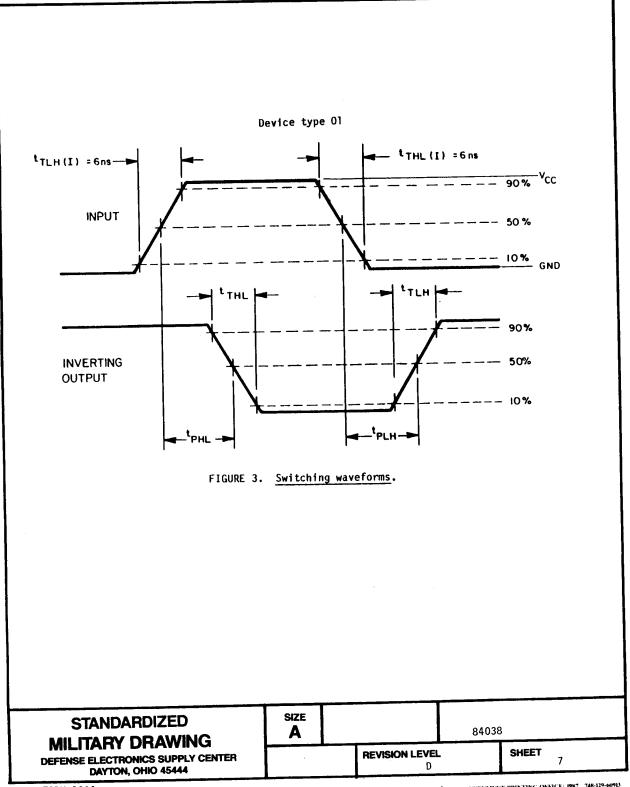
	INULL	I. Electrical performa		3 00 110 1110 2			
Test	Symbol	Condi -55°C < T _C < unless otherw	tions +125°C, 1/ ise specified	Group A	Lim Min	its Max 	Unit
Quiescent current	ICC	V _{CC} = 6.0 V V _{IN} =	V _{CC} or GND	1, 2, 3	<u> </u> 	40	μA
Input leakage current	IIIN	VCC = 6.0 V VIN =	1, 2, 3	 	 ±1 	 μ Α 	
Functional tests		See 4.3.1d	7				
Propagation delay time,	t _{PHL} ,	T _C = +25°C C _L = 50 pF ±10%	V _{CC} = 2.0 V	9		100	ns
high to low, low to high <u>2</u> /		 See figure 3 	V _{CC} = 4.5 V		 	20	
	 		V _{CC} = 6.0 V			17	
		T _C = -55°C, +125°C C _L = 50 pF ±10%	V _{CC} = 2.0 V	10, 11		150	ns
	1	See figure 3	V _{CC} = 4.5 V		 	30	
	† ! 		V _{CC} = 6.0 V		 	25	
Transition time,	tTHL,	T _C = +25°C C ₁ = 50 pF ±10%	V _{CC} = 2.0 V	9		75	l ns
low to high		L See figure 3	V _{CC} = 4.5 V		 	15	 <u> </u>
<u>3</u> /	İ	i 	V _{CC} = 6.0 V		 	1 13	
	İ	T _C = -55°C, +125°C C _L = 50 pF ±10%	V _{CC} = 2.0 V	10, 11		110	l ns
		See figure 3	V _{CC} = 4.5 V		 	22	<u> </u> -
	İ		V _{CC} = 6.0 V	Ţ		19	

^{1/} For a power supply of 5 V $\pm 10\%$ the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage currents (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used. Power dissipation capacitance (C_{PD}), typically 20 pF, determines the no load dynamic power consumption, P_D = C_{PD} V_{CC}2 f + I_{CC} V_{CC}, and the no load dynamic current consumption, I_S = C_{PD} V_{CC} f + I_{CC} V_{CC}, and the no 2/ Propagation delay times, when V_{CC} = 2.0 V and V_{CC} = 6.0 V shall be guaranteed if not tested to the specified parameters.

3/ Transition times (t_{THL} and t_{TLH}), if not tested, shall be guaranteed to the specified parameters.

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- 3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125$ °C, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroup 4 (C_{IN} measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance.
 - d. Subgroup 7 tests sufficient to verify the truth table.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125$ °C, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
 Interim electrical parameters (method 5004)	
 Final electrical test parameters (method 5004)	1*, 2, 3,7, 8, 9
Group A test requirements (method 5005)	1, 2, 3, 4, 7, 9, 10, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
 - 6.2 Replaceability. Replaceability is determined as follows:
 - a. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
 - b. When a QPL source is established, the part numbered device specified in this drawing will be replaced by the microcircuit identified as part number M38510/65002B--.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

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6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number 1/	Replacement military specification part number
8403801AX 2/ 8403801BX	01295	IMM54HC10W/883 ISNJ54HC10WA	M38510/65002BBX
8403801CX 3/	01295 04713 18714 27014	 SNJ54HC10J 54HC10/BCAJC CD54HC10F/3A MM54HC10J/883	M38510/65002BCX
8403801DX	01295	 SNJ54HC10W MM54HC10W/883	M38510/65002BDX
84038012X <u>4</u> /	01295 04713 27014	 SNJ54HC10FK 54HC10M/B2CJC MM54HC10E/883	M38510/65002B2X

- $\underline{1}/$ Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 2/ Not available from approved source of supply.
- 3/ Inactive for new design. Use M38510/65002BCX.
- 4/ Inactive for new design. Use M38510/65002B2X.

Vendor CAGE number	Vendor name and address
01295	Texas Instruments, Inc. PO Box 6448 Midland, TX 79701
04713	Motorola, Inc. 7402 S. Price Road Tempe, AZ 85283
18714	RCA Corp. Route 202 Somerville, NJ 08876
27014	National Semiconductor 2900 Semiconductor Drive Santa Clara, CA 95051
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